

■ PRODUCT CHARACTERISTICS

VDSS	60V
$R_{DS(on)typ}(V_{GS}=10V)$	3.5mΩ
$R_{DS(on)typ}(V_{GS}=4.5V)$	5.2mΩ
ID	114A

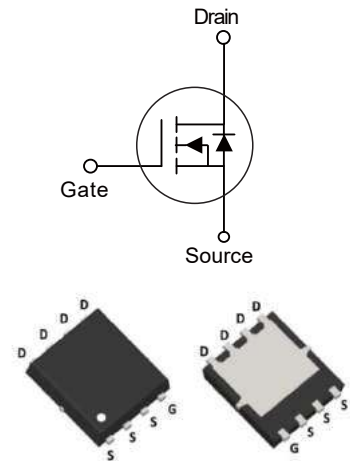
■ FEATURES

Advanced Trench Technology
Excellent $R_{DS(ON)}$ and Low Gate Charge
Lead free product is acquired

■ APPLICATION

PWM Applications
Load Switch
Power Management

Symbol



■ ORDER INFORMATION

Order codes		Package	Packing
Halogen-Free	Halogen		
N/A	MOT6129G	PDFN5X6-8L	5000 pieces /Reel

■ ABSOLUTE MAXIMUM RATINGS (T_C=25°C unless otherwise specified)

Parameter		Symbol	Value	Unit
Drain-to-Source Voltage		V _{DS}	60	V
Gate-to-Source Voltage		V _{GS}	±20	V
Continuous Drain Current	T _C = 25°C	I _D	114	A
	T _C = 100°C	I _D	72	A
Pulsed Drain Current		I _{DM}	411	A
Avalanche Energy		E _{AS}	182	mJ
Power Dissipation	T _C = 25°C	P _D	96	W
	T _C = 100°C	P _D	38	W
Thermal Resistance, Junction-to-Case		R _{θJC}	1.2	°C/W
Junction & Storage Temperature Range		T _J , T _{STG}	-55 to 150	°C

■ ELECTRICAL CHARACTERISTICS ($T_J=25^{\circ}\text{C}$ unless otherwise specified)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Static parameters						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$I_D = 250\mu\text{A}$, $V_{GS} = 0\text{V}$	60	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 48\text{V}$, $V_{GS} = 0\text{V}$	-	-	1.0	μA
		$T_J = 55^{\circ}\text{C}$	-	-	5.0	μA
Gate-Body Leakage Current	I_{GSS}	$V_{DS} = 0\text{V}$, $V_{GS} = \pm 20\text{V}$	-	-	± 100	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = 250\mu\text{A}$	1	-	2.5	V
Static Drain-Source ON-Resistance	$R_{DS(ON)}$	$V_{GS} = 10\text{V}$, $I_D = 20\text{A}$	-	3.2	4	$\text{m}\Omega$
		$V_{GS} = 4.5\text{V}$, $I_D = 15\text{A}$	-	5.2	6	$\text{m}\Omega$
Forward Transconductance	g_{FS}	$V_{DS} = 5\text{V}$, $I_D = 20\text{A}$	10	-	-	S
Diode Forward Voltage	V_{SD}	$I_S = 1\text{A}$, $V_{GS} = 0\text{V}$	-	0.70	1.0	V
Diode Continuous Current	I_S	$T_C = 25^{\circ}\text{C}$	-	-	96	A
Dynamic parameters						
Input Capacitance	C_{iss}	$V_{GS} = 0\text{V}$, $V_{DS} = 30\text{V}$, $f = 1\text{MHz}$	-	4300	-	pF
Output Capacitance	C_{oss}		-	963	-	pF
Reverse Transfer Capacitance	C_{rss}		-	64	-	pF
Gate Resistance	R_g	$V_{GS} = 0\text{V}$, $V_{DS} = 0\text{V}$, $f = 1\text{MHz}$	-	5.0	-	Ω
Switching parameters						
Total Gate Charge (@ $V_{GS} = 10\text{V}$)	Q_g	$V_{GS} = 0 \text{ to } 10\text{V}$ $V_{DS} = 30\text{V}$, $I_D = 20\text{A}$	-	39	-	nC
Total Gate Charge (@ $V_{GS} = 4.5\text{V}$)	Q_g		-	18.7	-	nC
Gate Source Charge	Q_{gs}		-	8.1	-	nC
Gate Drain Charge	Q_{gd}		-	7.3	-	nC
Turn-On DelayTime	$t_{D(on)}$	$V_{GS} = 10\text{V}$, $V_{DS} = 30\text{V}$ $R_L = 1.5\Omega$, $R_{GEN} = 3\Omega$	-	8.9	-	ns
Turn-On Rise Time	t_r		-	29	-	ns
Turn-Off DelayTime	$t_{D(off)}$		-	44	-	ns
Turn-Off Fall Time	t_f		-	22	-	ns
Body Diode Reverse Recovery Time	t_{rr}	$I_F = 20\text{A}$, $di_F/dt = 100\text{A}/\mu\text{s}$	-	38	-	ns
Body Diode Reverse Recovery Charge	Q_{rr}	$I_F = 20\text{A}$, $di_F/dt = 100\text{A}/\mu\text{s}$	-	28	-	nC

■ TYPICAL CHARACTERISTICS

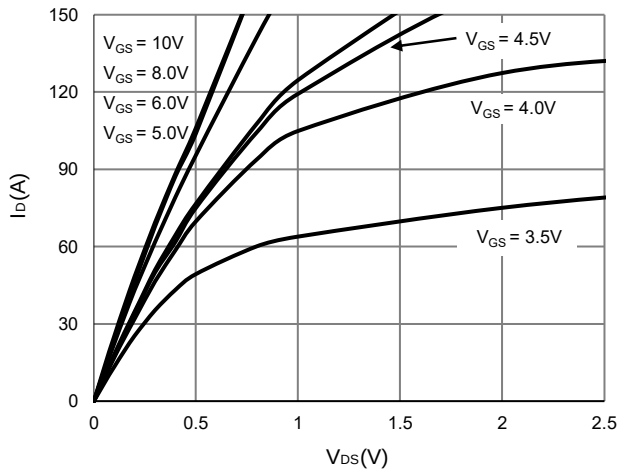


Figure 1: Saturation characteristics

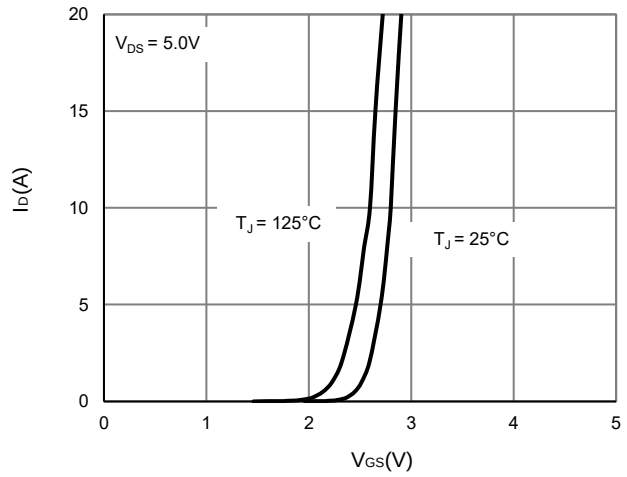


Figure 2: Transfer characteristics

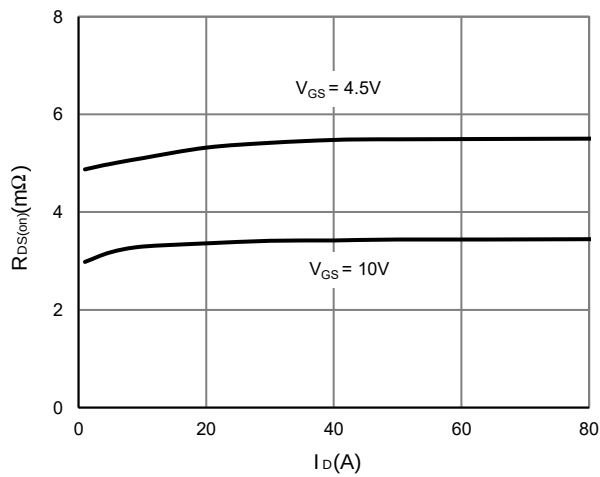


Figure 3: $R_{DS(ON)}$ vs. drain current

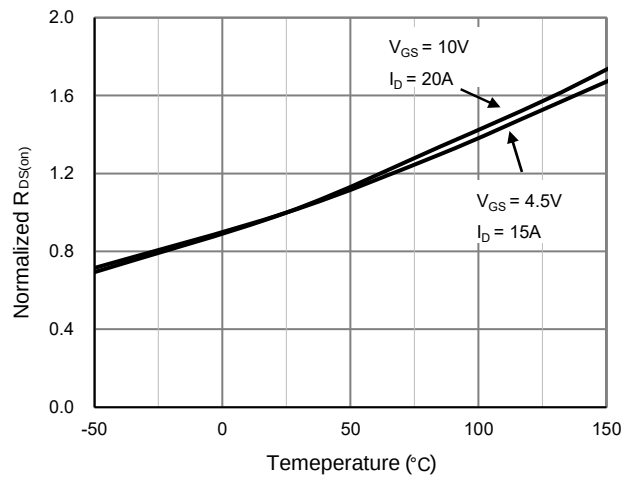


Figure 4: $R_{DS(ON)}$ vs. junction temperature

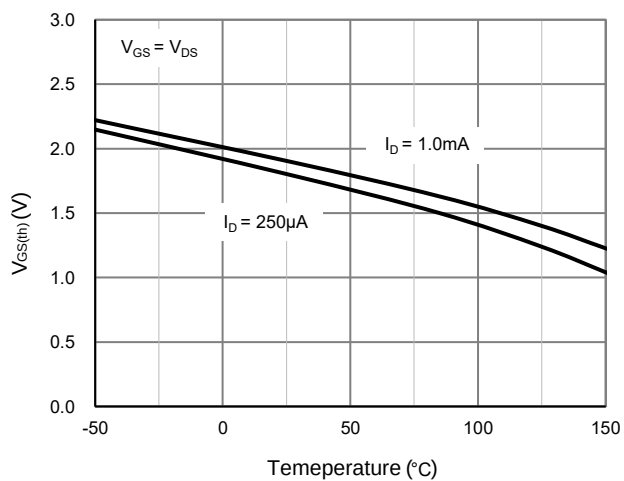


Figure 5: $V_{GS(th)}$ vs. junction temperature

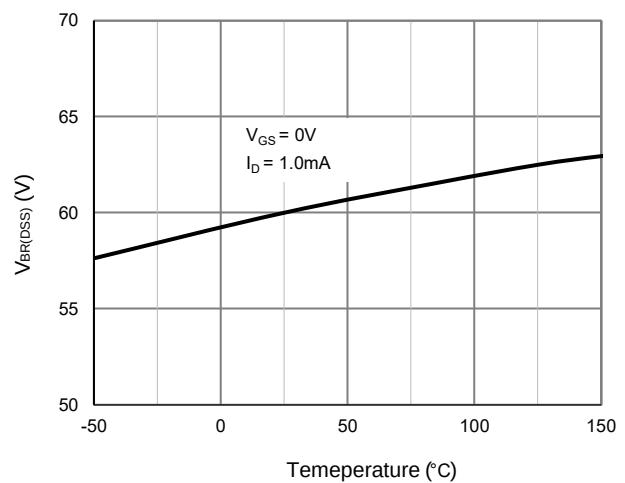


Figure 6: $V_{BR(DSS)}$ vs. junction temperature

■ TYPICAL CHARACTERISTICS(Cont.)

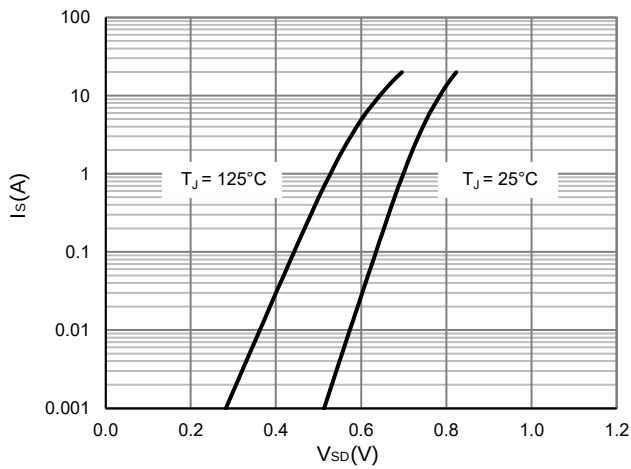


Figure 7: Body-diode characteristics

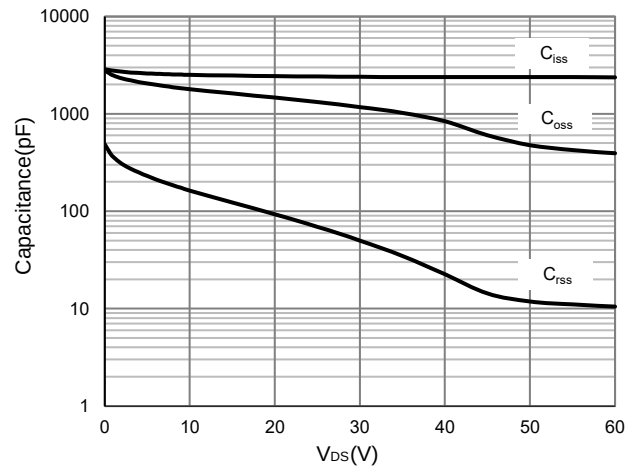


Figure 8: Capacitance characteristics

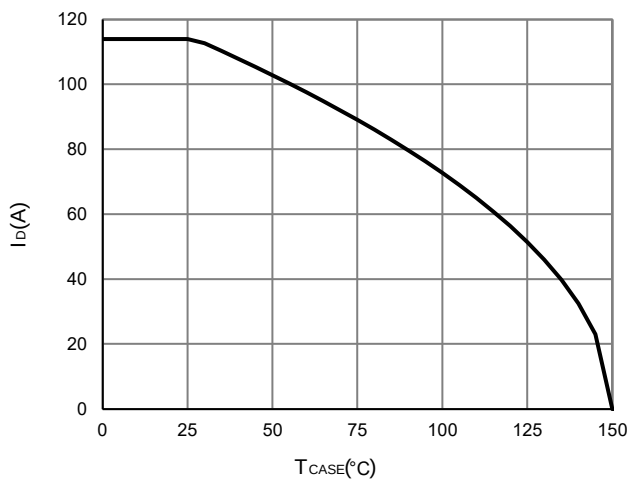


Figure 9: Current de-rating

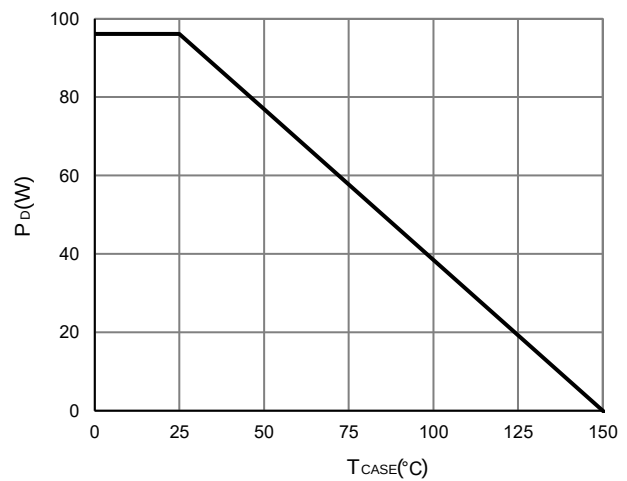


Figure 10: Power de-rating

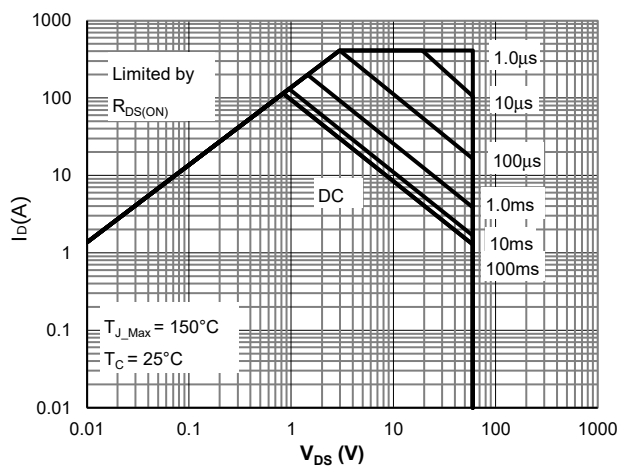
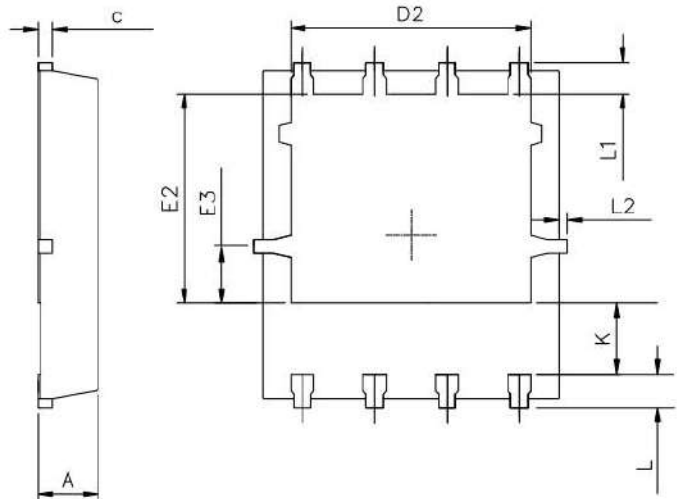
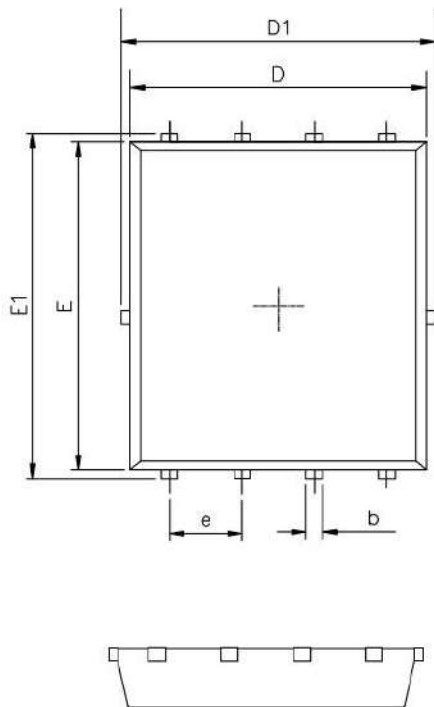
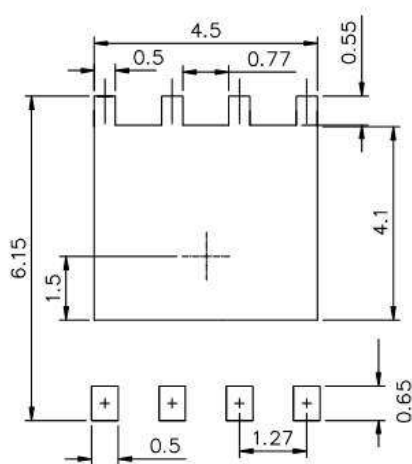


Figure 11: Maximum safe operating area

■ PDFN5X6-8L Package Mechanical Data



RECOMMENDED LAND PATTERN



UNIT:mm

	MIN	NOM	MAX
A	0.90	1.00	1.10
b	0.25	0.35	0.50
c	0.10	0.20	0.30
D	4.80	5.00	5.30
D1	4.90	5.10	5.50
D2	3.92	4.02	4.20
E	5.65	5.75	5.85
E1	5.90	6.05	6.20
E2	3.325	3.525	3.775
E3	0.80	0.90	1.00
e		1.27	
L	0.40	0.55	0.70
L1		0.65	
L2	0.00		0.15
K	1.00	1.30	1.50